查询PMEM1505NG供应



PMEM1505NG

NPN transistor/Schottky rectifier module

Rev. 02 — 31 August 2009

Product data sheet

1. Product profile

1.1 General description

Combination of an NPN transistor with low V_{CEsat} and high current capability and a planar Schottky barrier rectifier with an integrated guard ring for stress protection in a SOT353 (SC-88A) small plastic package. PNP complement: PMEM1505PG

1.2 Features

- **300** mW total power dissipation
- Current capability up to 0.5 A
- Reduces printed-circuit board area required
- Reduces pick and place costs
- Small plastic SMD package
- Transistor
 - Low collector-emitter saturation voltage.
- Diode
 - Ultra high-speed switching
 - Very low forward voltage
 - Guard ring protected

1.3 Applications

- DC-to-DC converters
- General purpose load drivers
- MOSFET drivers

1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
NPN trans	sistor						
V _{CEO}	collector-emitter voltage	open base		-	-	15	V
I _C	collector current (DC)	continuous	<u>[1]</u>	-	- 7	0.5	A
Schottky	barrier rectifier						
V _R	continuous reverse voltage				A1.44 .	20	V
I _F	continuous forward current				-	0.5	А

Inductive load drivers

Reverse polarity protection circuits

[1] Mounted on a FR4 printed-circuit board, single-sided copper, tin-plated, standard footprint for SOT353.





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2. Pinning information

Table 2.	Discrete pinning		
Pin	Description	Simplified outline	Symbol
1	anode		
5	cathode		
4	collector		
2	base		
3	emitter	<u> </u> 1 2 3	4 5
			sym023

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PMEM1505NG	-	plastic surface mounted package; 5 leads	SOT353

4. Marking

Table 4. Marking	
Type number	Marking code ^[1]
PMEM1505NG	L7*

[1] * = p: made in Hong Kong

- * = t: made in Malaysia
- * = W: made in China

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
NPN transis	stor					
V _{CBO}	collector-base voltage	open emitter		-	15	V
V _{CEO}	collector-emitter voltage	open base		-	15	V
V _{EBO}	emitter-base voltage	open collector		-	6	V
I _C	collector current (DC)	continuous	<u>[1]</u>	-	0.5	А
		continuous	[2]	-	0.6	А
		continuous; T _s ≤ 55 °C	<u>[3]</u>	-	1	A
I _{CM}	peak collector current			-	1	А
I _{BM}	peak base current			-	100	mA

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Symbol	Parameter	Conditions		Min	Max	Unit
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u>	-	200	mW
		$T_{amb} \le 25 \ ^{\circ}C$	[2]	-	250	mW
		$T_s \le 55 \ ^\circ C$	[3]	-	800	mW
Tj	junction temperature			-	150	°C
Schottky	barrier rectifier					
V _R	continuous reverse voltage			-	20	V
I _F	continuous forward current			-	0.5	А
I _{FSM}	non-repetitive peak forward current	t = 8.3 ms; square wave		-	5	А
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	[1]	-	100	mW
		$T_{amb} \le 25 \ ^{\circ}C$	[2]	-	200	mW
		$T_s \le 55 \ ^\circ C$	[3]	-	800	mW
Tj	junction temperature		[2]	-	125	°C
Combined	I device					
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	[2]	-	300	mW
T _{stg}	storage temperature			-65	+150	°C
T _{amb}	operating ambient temperature		[2]	-65	+125	°C

Table 5. Limiting values ... continued

[1] Mounted on a FR4 printed-circuit board, single-sided copper, tin-plated, standard footprint for SOT353.

Device mounted on a printed-circuit board, single-sided copper, tin-plated, 1cm² mounting pad for both [2] collector and cathode.

[3] Solder point of collector or cathode tab.

Thermal characteristics 6.

Table 6.	Thermal characteristics ^[1]				
Symbol	Parameter	Conditions		Тур	Unit
Single de	evice				
R _{th(j-s)}	thermal resistance from junction to solder point	in free air	[2]	120	K/W
R _{th(j-a)}	thermal resistance from junction	in free air	[3]	395	K/W
	to ambient		[4]	495	K/W
Combine	d device				
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	[5]	410	K/W

parrier rectifiers thermal run-away has to be considered, as in some appli [1] For power losses P_R are a significant part of the total power losses. Nomograms for determining the reverse power losses P_R and $\mathsf{I}_{\mathsf{F}(\mathsf{AV})}$ rating will be available on request.

- [2] Solder point of collector or cathode tab.
- Device mounted on a printed-circuit board, single-sided copper, tin-plated, 1cm² mounting pad for both [3] collector and cathode.
- Mounted on a FR4 printed-circuit board, single-sided copper, tin-plated, standard footprint for SOT353. [4]
- [5] Mounted on a ceramic printed-circuit board, single-sided copper, tin-plated, standard footprint.

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7. Characteristics

Table 7. T _{amb} = 25 ° (Characteristics C unless otherwise spec	ified					
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
NPN transi	stor						
I _{CBO}	collector-base cut-off	$V_{CB} = 15 \text{ V}; I_E = 0 \text{ A}$		-	-	100	nA
	current	$V_{CB} = 15 \text{ V}; I_E = 0 \text{ A};$ $T_j = 150 \text{ °C}$		-	-	50	μΑ
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 V; I_C = 0 A$		-	-	100	nA
h _{FE}	DC current gain	$V_{CE} = 2 \text{ V}; I_{C} = 10 \text{ mA}$		200	-	-	
		$V_{CE} = 2 \text{ V}; I_{C} = 100 \text{ mA}$		150	-	-	
		$V_{CE} = 2 \text{ V}; I_{C} = 500 \text{ mA}$		90	-	-	
V _{CEsat}	collector-emitter	$I_{C} = 10 \text{ mA}; I_{B} = 0.5 \text{ mA}$		-	-	25	mV
	saturation voltage	$I_C = 200 \text{ mA}; I_B = 10 \text{ mA}$		-	-	150	mV
		$I_C = 500 \text{ mA}; I_B = 50 \text{ mA}$		-	-	250	mV
R _{CEsat}	equivalent on-resistance	$I_{\rm C}$ = 500 mA; $I_{\rm B}$ = 50 mA	<u>[1]</u>	-	300	< 500	mΩ
V _{BEsat}	base-emitter saturation voltage	$I_{\rm C}$ = 500 mA; $I_{\rm B}$ = 50 mA	<u>[1]</u>	-	-	1.1	V
V _{BEon}	base-emitter turn-on voltage	V_{CE} = 2 V; I _C = 100 mA	<u>[1]</u>	-	-	0.9	V
f _T	transition frequency	$V_{CE} = 5 \text{ V}; I_C = 100 \text{ mA};$ f = 100 MHz		250	420	-	MHz
C _c	collector capacitance	V_{CB} = 10 V; I_E = I_e = 0 A; f = 1 MHz		-	4.4	6	pF
Schottky b	arrier rectifier						
V _F	continuous forward	see Figure 1					
	voltage	I _F = 10 mA	<u>[1]</u>	-	240	270	mV
		I _F = 100 mA	<u>[1]</u>	-	300	350	mV
		I _F = 500 mA	<u>[1]</u>	-	400	460	mV
		I _F = 1000 mA	<u>[1]</u>	-	480	550	mV
I _R	reverse current	see Figure 2					
		V _R = 5 V	<u>[1]</u>	-	5	10	μΑ
		V _R = 8 V	<u>[1]</u>	-	7	20	μΑ
		V _R = 15 V	<u>[1]</u>	-	10	50	μΑ
C _d	diode capacitance	V _R = 5 V; f = 1 MHz; see Figure 3		-	19	25	pF

[1] Pulse test: $t_p \le 300 \ \mu s; \ \delta \le 0.02$

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8. Application information



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9. Package outline



Fig 10. Package outline

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10. Revision history

Table 8. Revision histo	ry			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PMEM1505NG_2	20090831	Product data	-	PMEM1505NG_1
Modifications:	 This data sheet including new le content. 	was changed to reflect the gal definitions and disclaim	new company name ners. No changes wer	NXP Semiconductors, e made to the technical
	Table 2 "Discrete	e pinning": amended		
	 Figure 10 "Pack 	age outline":updated		
PMEM1505NG_1	20040525	Product data	-	-

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11. Legal information

11.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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